

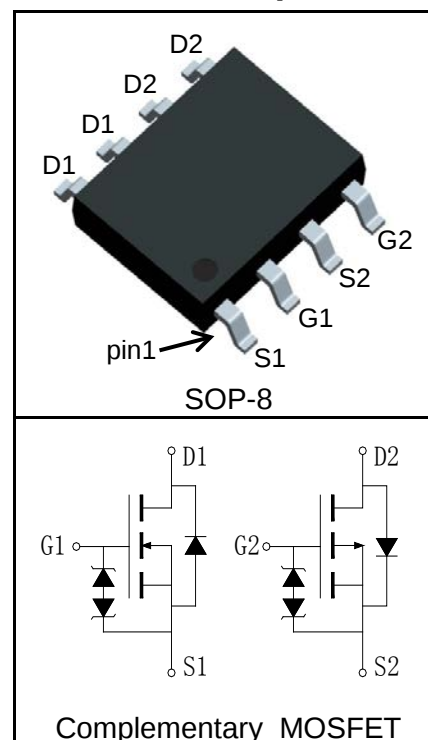
Features

- N-Channel
30V/8A,
 $R_{DS(ON)} = 12m\Omega(Typ.) @ V_{GS}=10V$
 $R_{DS(ON)} = 16m\Omega(Typ.) @ V_{GS}=4.5V$
- P-Channel
-30V/-7A,
 $R_{DS(ON)} = 18m\Omega(Typ.) @ V_{GS}=-10V$
 $R_{DS(ON)} = 25m\Omega(Typ.) @ V_{GS}=-4.5V$
- Reliable and Rugged
- ESD Protected
- Lead Free and Green Devices Available (RoHS Compliant)

Applications

- Load Switch

Pin Description



Absolute Maximum Ratings

Symbol	Parameter		N-Channel	P-Channel	Unit
Common Ratings (T _A =25°C Unless Otherwise Noted)					
V _{DSS}	Drain-Source Voltage		30	-30	V
V _{GSS}	Gate-Source Voltage		±12	±12	
T _J	Maximum Junction Temperature		150	150	°C
T _{STG}	Storage Temperature Range		-55 to 150	-55 to 150	°C
I _S	Diode Continuous Forward Current	T _A =25°C	2.7	-2.5	A
Mounted on Large Heat Sink					
I _{DP} ^①	300μs Pulse Drain Current Tested	T _A =25°C	32	-28	A
I _D ^②	Continuous Drain Current(V _{GS} =±10V)	T _A =25°C	8	-7	A
		T _A =70°C	6.5	-5.6	
P _D	Maximum Power Dissipation	T _A =25°C	2	2	W
		T _A =70°C	1.3	1.3	
R _{θJC}	Thermal Resistance-Junction to Case		TBD	TBD	°C/W
R _{θJA} ^③	Thermal Resistance-Junction to Ambient		62.5	62.5	°C/W
Drain-Source Avalanche Ratings					
E _{AS} ^④	Avalanche Energy, Single Pulsed		TBD	TBD	mJ

Electrical Characteristics ($T_A=25^{\circ}\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	RU30C8H			Unit		
			Min.	Typ.	Max.			
Static Characteristics								
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	N	30			V	
		V _{GS} =0V, I _{DS} =-250μA	P	-30				
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V	N			1	μA	
				T _J =125°C				30
		V _{DS} =-30V, V _{GS} =0V	P			-1		-30
				T _J =125°C				
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	N	1.2	1.8	2.4	V	
		V _{DS} =V _{GS} , I _{DS} =-250μA	P	-1.2	-1.8	-2.4		
I _{GSS}	Gate Leakage Current	V _{GS} =±12V, V _{DS} =0V	N			±10	μA	
		V _{GS} =±12V, V _{DS} =0V	P			±10		
R _{DS(ON)} ⑤	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =8A	N		12	15	mΩ	
		V _{GS} =-10V, I _{DS} =-6A	P		18	25		
		V _{GS} =4.5V, I _{DS} =7A	N		16	25		
		V _{GS} =-4.5V, I _{DS} =-5A	P		25	35		
Diode Characteristics								
V _{SD} ⑤	Diode Forward Voltage	I _{SD} =1A, V _{GS} =0V	N			1.2	V	
		I _{SD} =-1A, V _{GS} =0V	P			-1.2		
t _{rr}	Reverse Recovery Time	N-Channel I _{SD} =8A, dI _{SD} /dt=100A/μs	N		12		ns	
			P		17			
Q _{rr}	Reverse Recovery Charge	P-Channel I _{SD} =-7A, dI _{SD} /dt=100A/μs	N		3		nC	
			P		9			
Dynamic Characteristics ⑥								
R _G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	N		1.8		Ω	
			P		3			
C _{iss}	Input Capacitance	N-Channel V _{GS} =0V, V _{DS} =15V, Frequency=1.0MHz	N		340		pF	
			P		780			
C _{oss}	Output Capacitance		N		75			
			P		155			
C _{rss}	Reverse Transfer Capacitance	P-Channel V _{GS} =0V, V _{DS} =-15V, Frequency=1.0MHz	N		50			
			P		95			

Electrical Characteristics ($T_A=25^{\circ}\text{C}$ Unless Otherwise Noted)

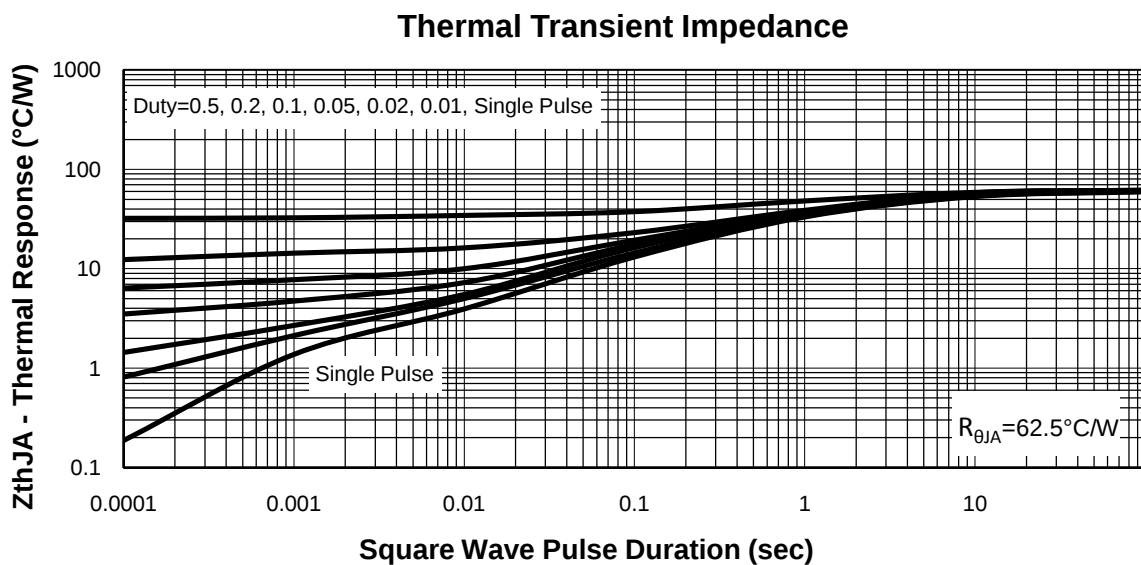
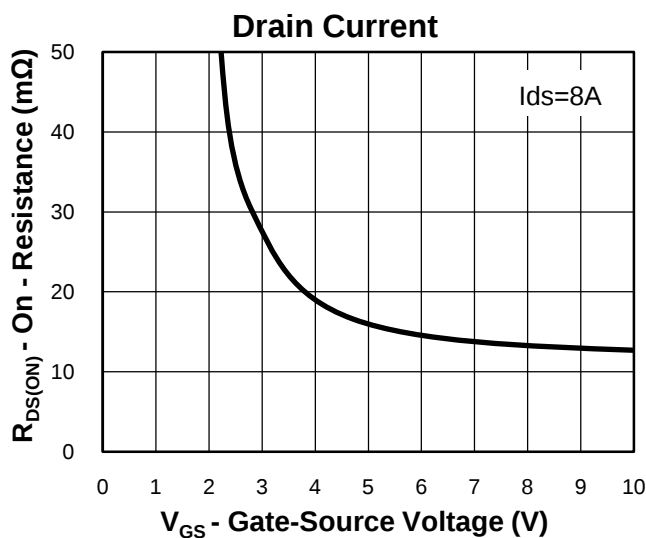
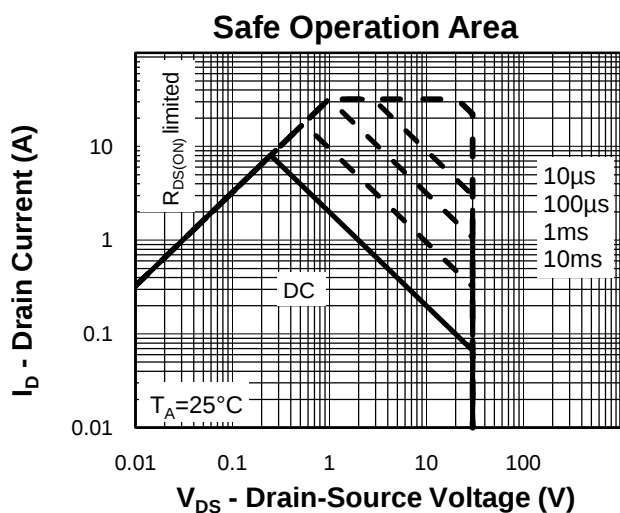
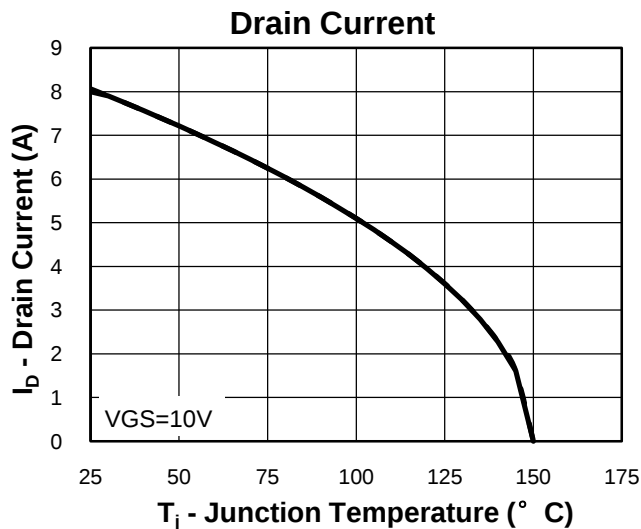
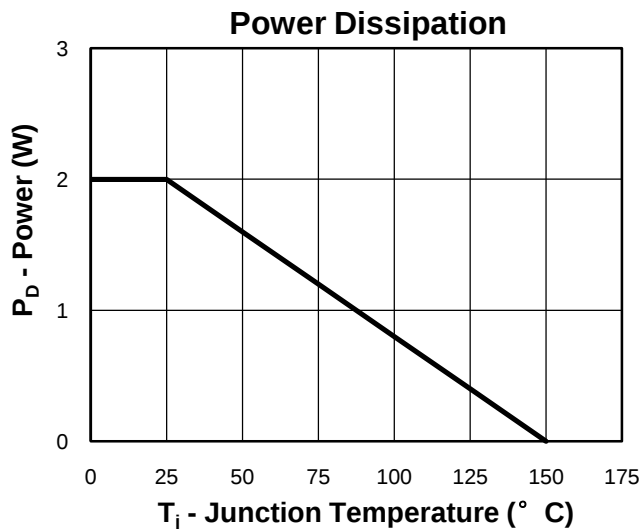
Symbol	Parameter	Test Condition	RU30C8H				Unit
			Min.	Typ.	Max.		
Dynamic Characteristics ^⑥							
t _{d(ON)}	Turn-on Delay Time	N-Channel V _{DD} =15V, I _{DS} =8A, V _{GEN} =10V, R _G =6Ω P-Channel V _{DD} =-15V, I _{DS} =-7A, V _{GEN} = -10V, R _G =6Ω	N		5		ns
			P		9		
t _r	Turn-on Rise Time		N		3		
			P		6		
t _{d(OFF)}	Turn-off Delay Time		N		15		
			P		21		
t _f	Turn-off Fall Time		N		4		
			P		7		
Gate Charge Characteristics ^⑥							
Q _g	Total Gate Charge	N-Channel V _{DS} =24V, V _{GS} =10V, I _{DS} =8A P-Channel V _{DS} =-24V, V _{GS} = -10V, I _{DS} =-7A	N		8		nC
			P		15		
Q _{gs}	Gate-Source Charge		N		1.2		
			P		2.5		
Q _{gd}	Gate-Drain Charge		N		2		
			P		3.5		

- Notes:
- ① Pulse width limited by safe operating area.
 - ② Calculated continuous current based on maximum allowable junction temperature.
 - ③ When mounted on 1 inch square copper board, $t \leq 10\text{sec}$. The value in any given application depends on the user's specific board design.
 - ④ Limited by T_{Jmax} . Starting $T_J = 25^{\circ}\text{C}$.
 - ⑤ Pulse test; Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
 - ⑥ Guaranteed by design, not subject to production testing.

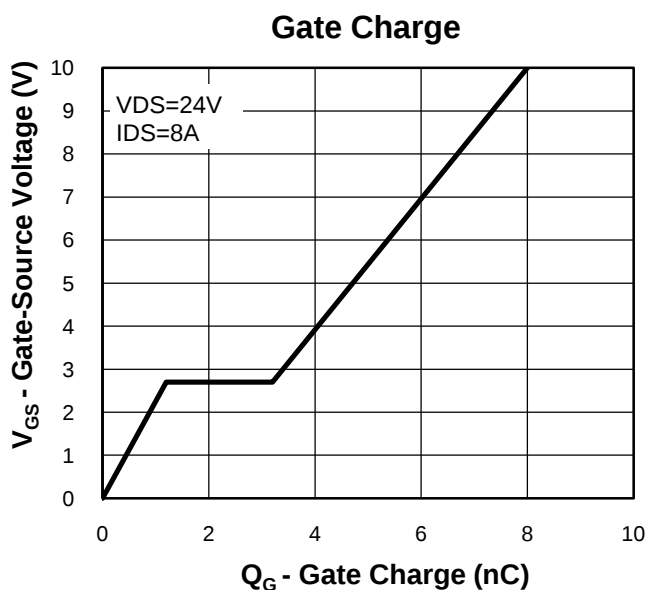
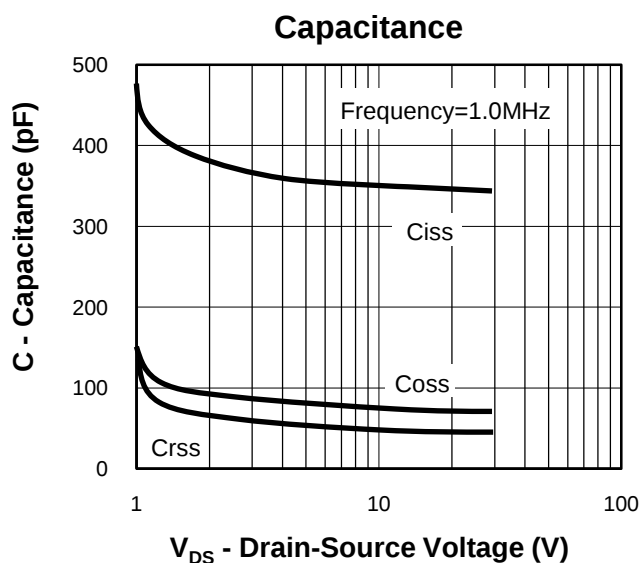
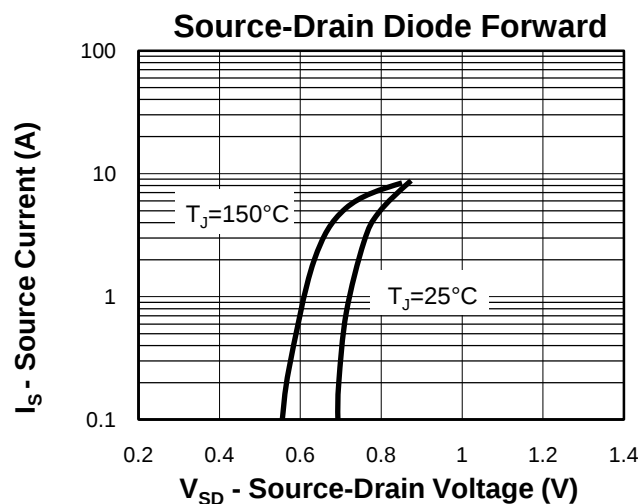
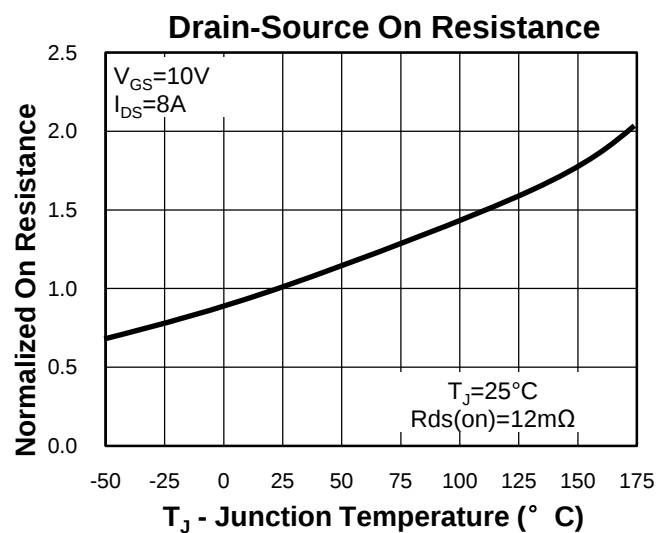
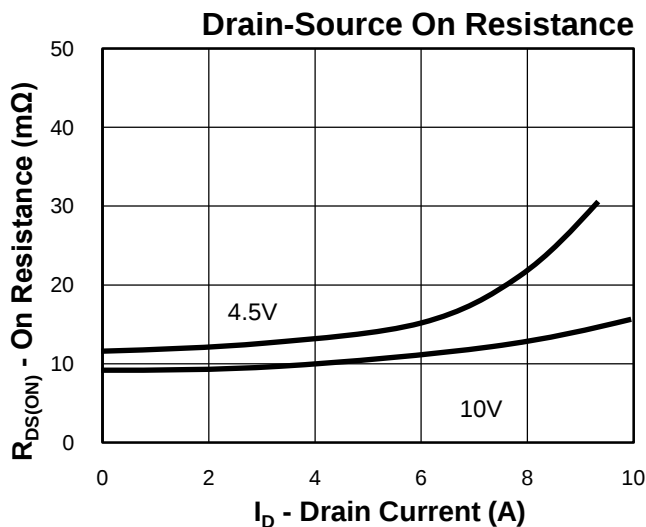
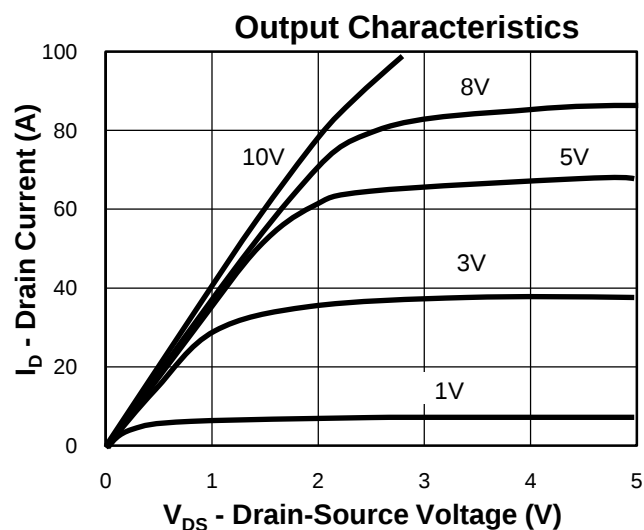
Ordering and Marking Information

Device	Marking	Package	Packaging	Quantity	Reel Size	Tape width
RU30C8H	RU30C8H	SOP-8	Tape&Reel	2500	13"	12mm

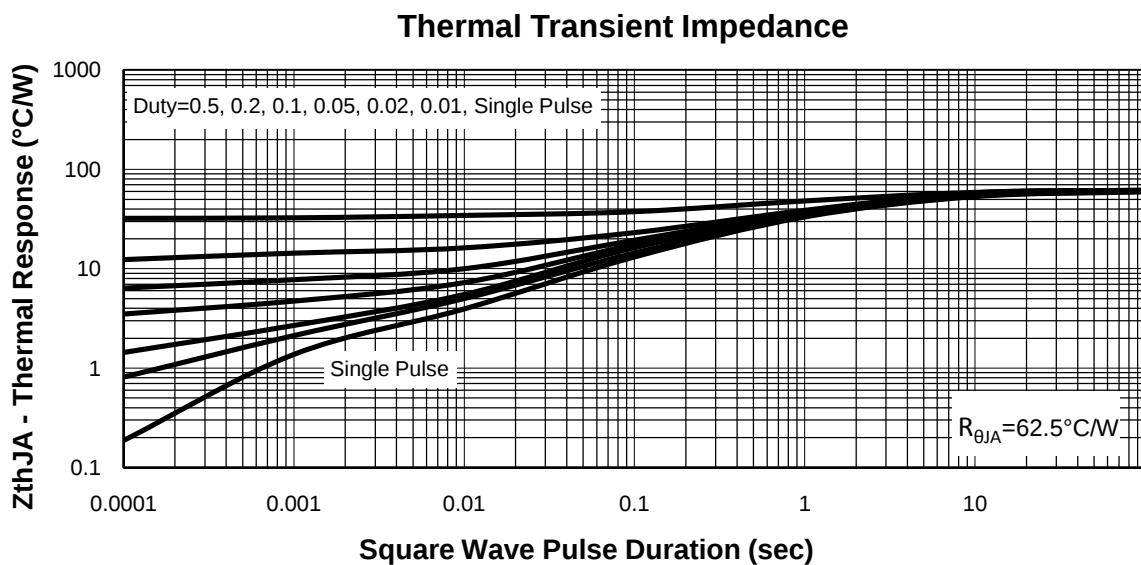
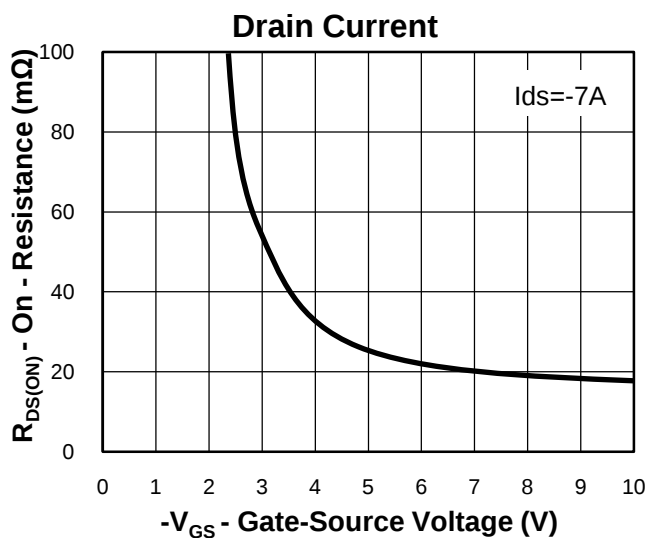
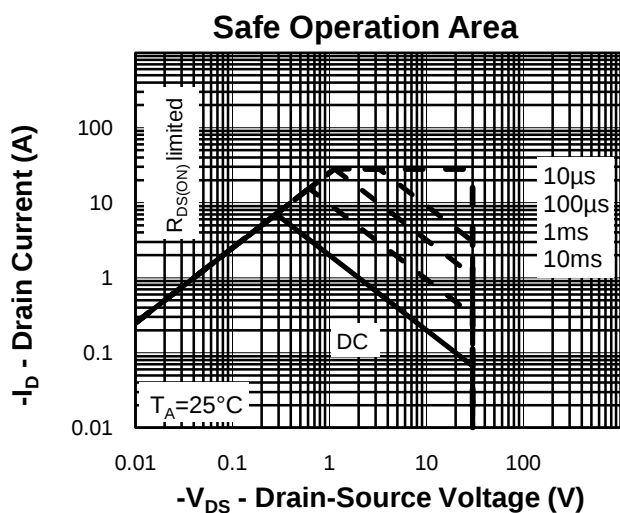
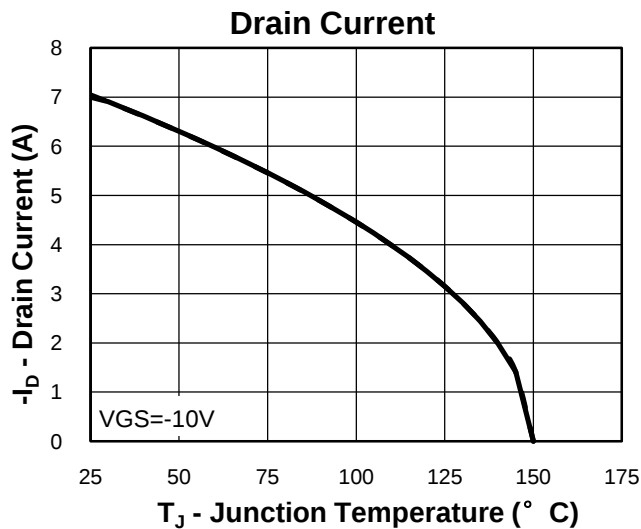
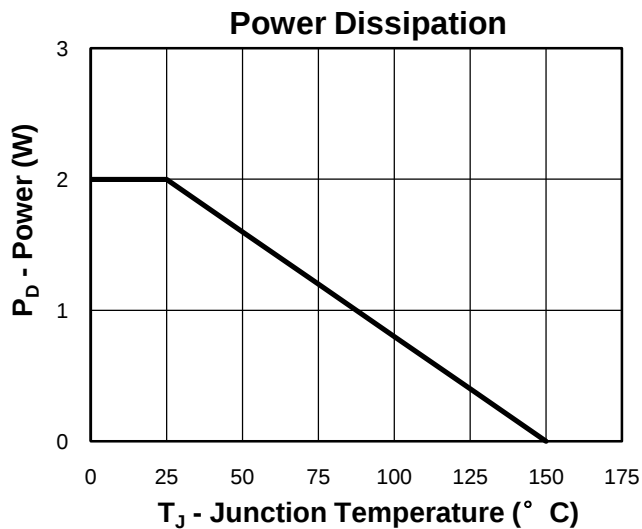
Typical Characteristics(N-Channel)



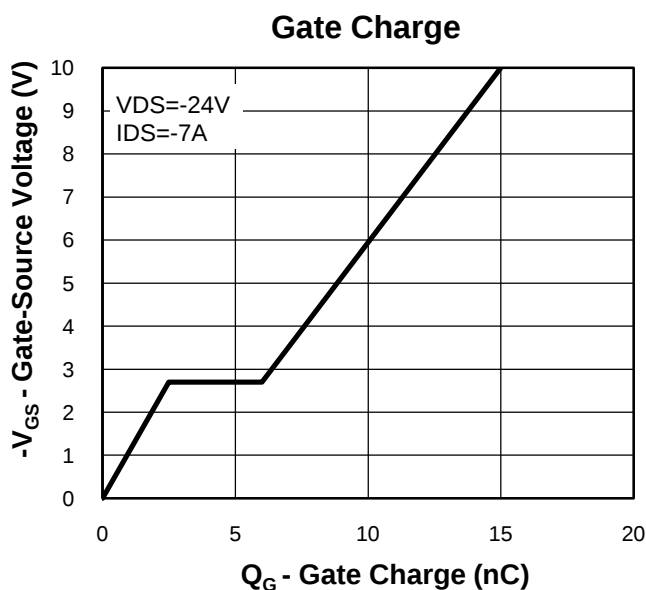
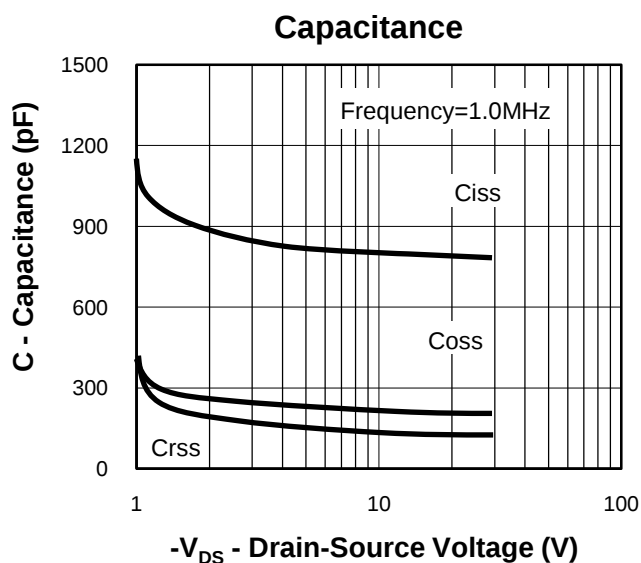
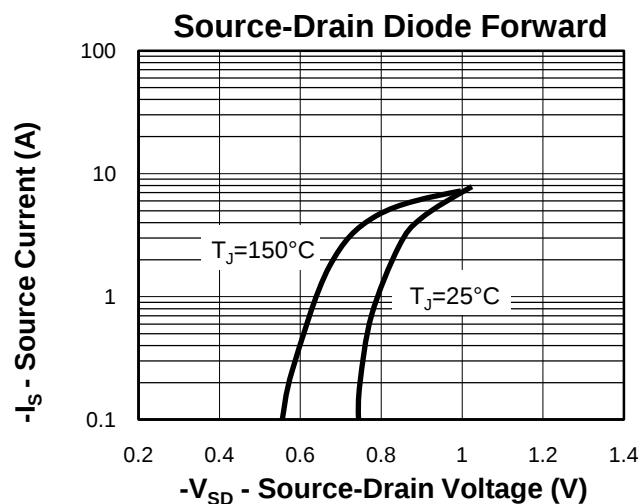
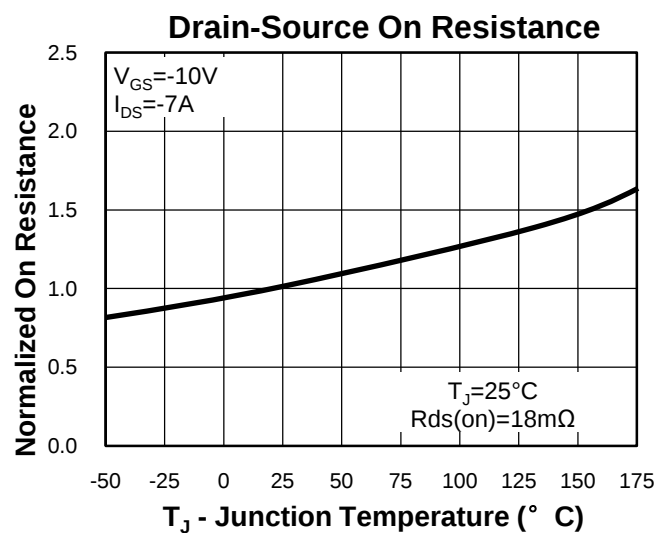
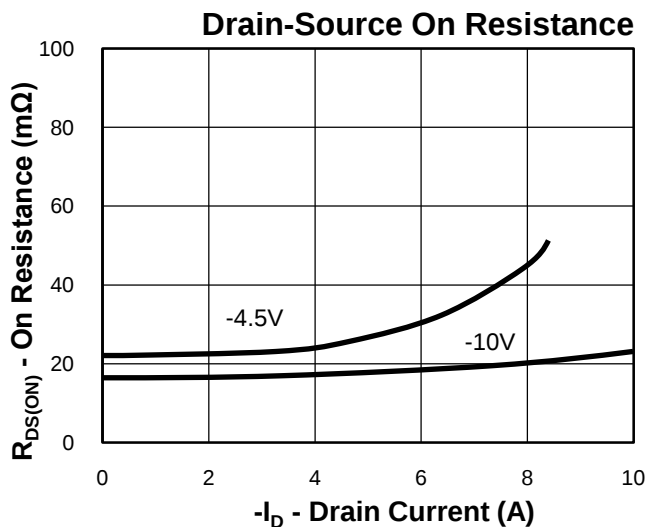
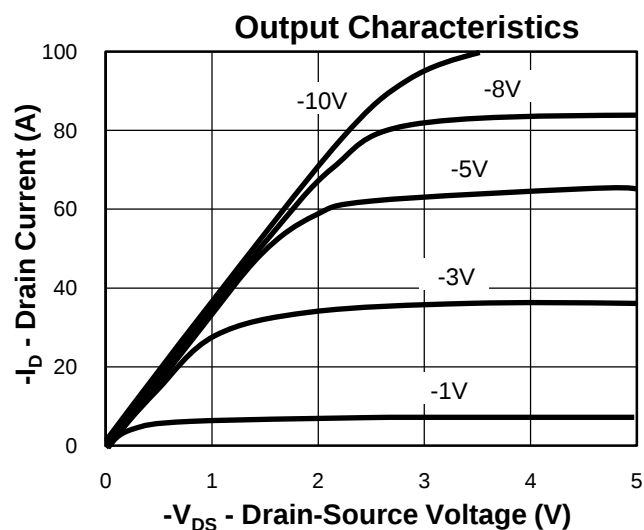
Typical Characteristics(N-Channel)



Typical Characteristics(P-Channel)

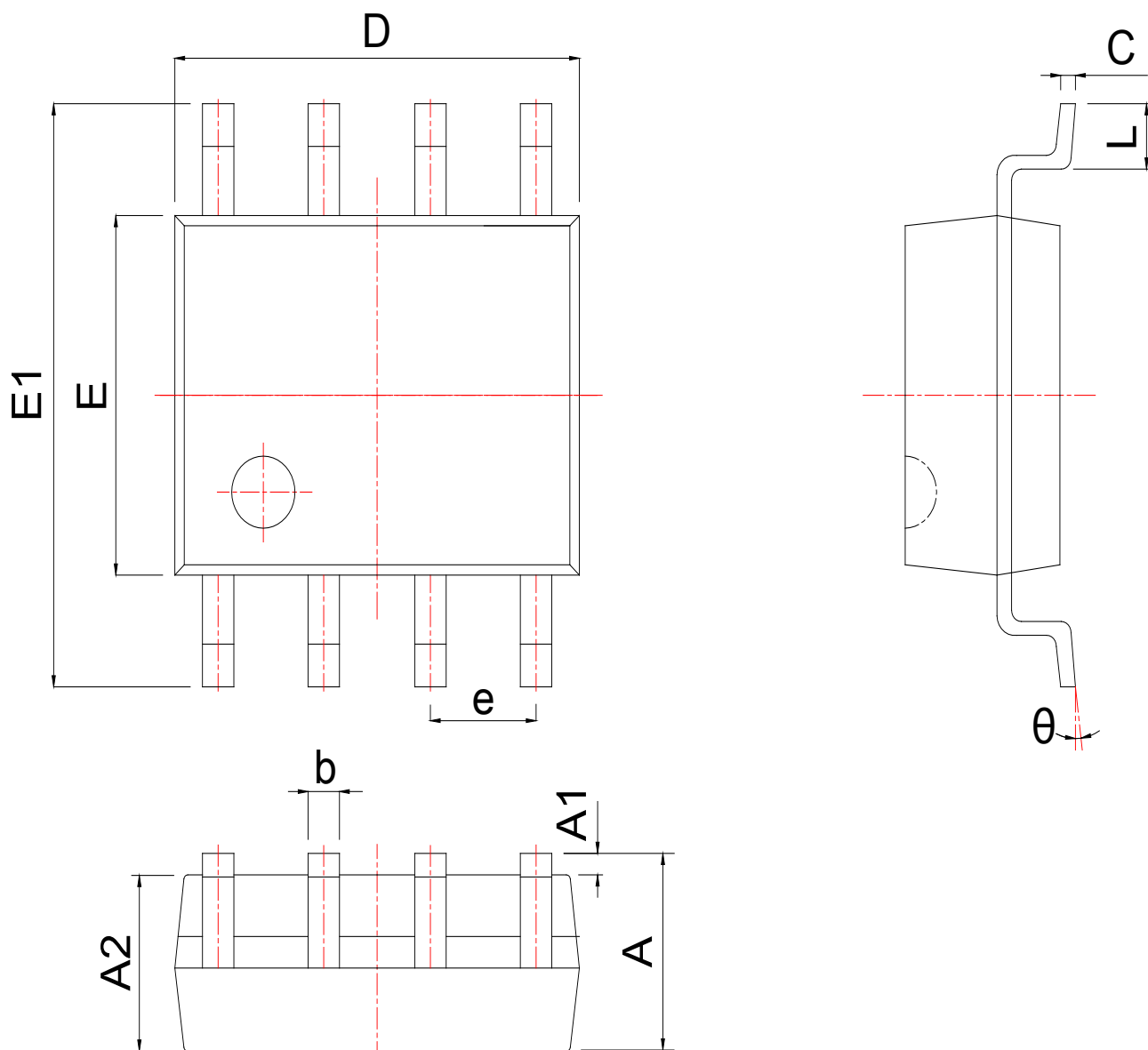


Typical Characteristics(P-Channel)



Package Information

SOP-8



SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.300	1.525	1.750	0.051	0.060	0.069
A1	0.050	0.150	0.250	0.002	0.006	0.010
A2	1.350	1.450	1.550	0.053	0.057	0.061
b	0.330	0.420	0.510	0.013	0.017	0.020
c	0.170	0.210	0.250	0.007	0.008	0.010
D	4.700	4.900	5.100	0.185	0.193	0.201
E	3.800	3.900	4.000	0.150	0.154	0.157
E1	5.800	6.000	6.200	0.228	0.236	0.244
e	1.270 BSC			0.050 BSC		
L	0.400	0.835	1.270	0.016	0.033	0.050
θ	0°		8°	0°		8°

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